



Please type a plus sign (+) inside this box → [ + ]

PTO/SB/21 (08-00)

Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

<b>TRANSMITTAL FORM</b> (to be used for all correspondence after initial filing)	Application Number	09/995,866	
	Filing Date	November 29, 2001	
	First Named Inventor	Akira MASE et al.	
	Group Art Unit	1732	
	Examiner Name	Unassigned	
Total Number of Pages in This Submission	4	Attorney Docket Number	0756-2401

ENCLOSURES (check all that apply)		
<input type="checkbox"/> Fee Transmittal Form <input type="checkbox"/> Fee Attached <input type="checkbox"/> Amendment / Reply <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input type="checkbox"/> Information Disclosure Statement <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Response to Missing Parts/Incomplete Application <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers (for an Application) <input type="checkbox"/> Drawing(s) <input type="checkbox"/> Declaration and Power of Attorney <input type="checkbox"/> Licensing-related Papers <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s) _____	<input type="checkbox"/> After Allowance Communication to Group <input checked="" type="checkbox"/> Other - Preliminary Amendment
Remarks		<b>RECEIVED</b> MAY 28 2002 TC 1700 COPY OF PAPERS ORIGINALLY FILED
<input type="checkbox"/> The Commissioner is hereby authorized to charge any additional fees required or credit any overpayments to Deposit Account No. _____ for the above identified docket number.		

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT	
Firm or Individual name	Eric J. Robinson Robinson Intellectual Property Law Office PMB955 21010 Southbank Street, Potomac Falls, Virginia 20165
Signature	
Date	May 10, 2002

CERTIFICATE OF MAILING	
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on this date: <b>5-10-02</b>	
Type or printed name	Rose M. Fichtel
Signature	
Date	May 10, 2002

Burden Hour Statement: This form is estimated to take 0.2 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, Washington, DC 20231.



- 1 -

Docket No. 0756-2401

7/Pre Amdt A  
8/1/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: )

Akira MASE et al. )

Serial No. 09/995,866 )

Filed: November 29, 2001 )

For: CONDUCTIVE PATTERN PRODUCING )

METHOD AND ITS APPLICATIONS )

Examiner: Unassigned

Group Art Unit: 1732

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with The United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on May 10, 2002

Rose M. Fichter

PRELIMINARY AMENDMENT

Commissioner for Patents  
Washington, DC 20231

Sir:

Please preliminarily amend the above-identified application as follows:

IN THE CLAIMS:

Please cancel claim 1 in its entirety.

Please add new claims 2-9 as follows:

--2. A display device comprising:

a glass substrate;

a lead formed over the glass substrate, said lead comprising a first layer comprising silver and a second layer comprising indium tin oxide formed on the first layer;

an IC chip provided over the glass substrate and electrically connected to the lead wherein a pad of the IC chip is electrically connected to the second layer of the lead.

RECEIVED  
MAY 28 2002

TC 1700

COPY OF PAPERS  
ORIGINALLY FILED